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Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	LED, LVD, POR, PWM
Number of I/O	14
Program Memory Size	1.5KB (1.5K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.3V
Data Converters	A/D 12x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mcr908jk1cdwe

Addr.	Register Name	Bit 7	6	5	4	3	2	1	Bit 0
\$000B ↓ \$000C	Unimplemented	Read: [] Write: []	[]	[]	[]	[]	[]	[]	[]
\$000D	Port A Input Pull-up Enable Register (PTAPUE)	Read: PTA6EN Write: PTA6EN	PTAPUE6	PTAPUE5	PTAPUE4	PTAPUE3	PTAPUE2	PTAPUE1	PTAPUE0
		Reset: 0	0	0	0	0	0	0	0
\$000E ↓ \$0019	Unimplemented	Read: [] Write: []	[]	[]	[]	[]	[]	[]	[]
\$001A	Keyboard Status and Control Register (KBSCR)	Read: 0 Write: []	0	0	0	KEYF	0	IMASKK	MODEK
		Reset: 0	0	0	0	0	0		
\$001B	Keyboard Interrupt Enable Register (KBIER)	Read: 0 Write: []	KBIE6	KBIE5	KBIE4	KBIE3	KBIE2	KBIE1	KBIE0
		Reset: 0	0	0	0	0	0	0	0
\$001C	Unimplemented	Read: [] Write: []	[]	[]	[]	[]	[]	[]	[]
\$001D	IRQ Status and Control Register (INTSCR)	Read: 0 Write: []	0	0	0	IRQF1	0	IMASK1	MODE1
		Reset: 0	0	0	0	0	0		
\$001E	Configuration Register 2 (CONFIG2) [†]	Read: IRQPUD Write: IRQPUD	R	R	LVIT1	LVIT0	R	R	R
		Reset: 0	0	0	0*	0*	0	0	0
\$001F	Configuration Register 1 (CONFIG1) [†]	Read: COPRS Write: COPRS	R	R	LVID	R	SSREC	STOP	COPD
		Reset: 0	0	0	0	0	0	0	0
† One-time writable register after each reset. * LVIT1 and LVIT0 reset to logic 0 by a power-on reset (POR) only.									
\$0020	TIM Status and Control Register (TSC)	Read: TOF Write: 0	TOIE	TSTOP	0	0	PS2	PS1	PS0
		Reset: 0	0	1	0	0	0	0	0
[] = Unimplemented [R] = Reserved									

Figure 2-2. Control, Status, and Data Registers (Sheet 2 of 5)

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
\$002B	Unimplemented	Read:								
\$003B		Write:								
\$003C	ADC Status and Control Register (ADSCR)	Read:	COCO	AIEN	ADCO	CH4	CH3	CH2	CH1	CH0
		Write:								
		Reset:	0	0	0	1	1	1	1	1
\$003D	ADC Data Register (ADR)	Read:	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
		Write:								
		Reset:	Indeterminate after reset							
\$003E	ADC Input Clock Register (ADICLK)	Read:	ADIV2	ADIV1	ADIV0	0	0	0	0	0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
\$003F	Unimplemented	Read:								
		Write:								
\$FE00	Break Status Register (BSR)	Read:	R	R	R	R	R	R	SBSW	R
		Write:							See note	
		Reset:	0							
Note: Writing a logic 0 clears SBSW.										
\$FE01	Reset Status Register (RSR)	Read:	POR	PIN	COP	ILOP	ILAD	MODRST	LVI	0
		Write:								
		POR:	1	0	0	0	0	0	0	0
\$FE02	Reserved	Read:	R	R	R	R	R	R	R	R
		Write:								
\$FE03	Break Flag Control Register (BFCR)	Read:	BCFE	R	R	R	R	R	R	R
		Write:								
		Reset:	0							
\$FE04	Interrupt Status Register 1 (INT1)	Read:	0	IF5	IF4	IF3	0	IF1	0	0
		Write:	R	R	R	R	R	R	R	R
		Reset:	0	0	0	0	0	0	0	0
				= Unimplemented			R	= Reserved		

Figure 2-2. Control, Status, and Data Registers (Sheet 4 of 5)

Section 3. Random-Access Memory (RAM)

3.1 Contents

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3.3 Functional Description37

3.2 Introduction

This section describes the 128 bytes of RAM.

3.3 Functional Description

Addresses \$0080 through \$00FF are RAM locations. The location of the stack RAM is programmable. The 16-bit stack pointer allows the stack to be anywhere in the 64-Kbyte memory space.

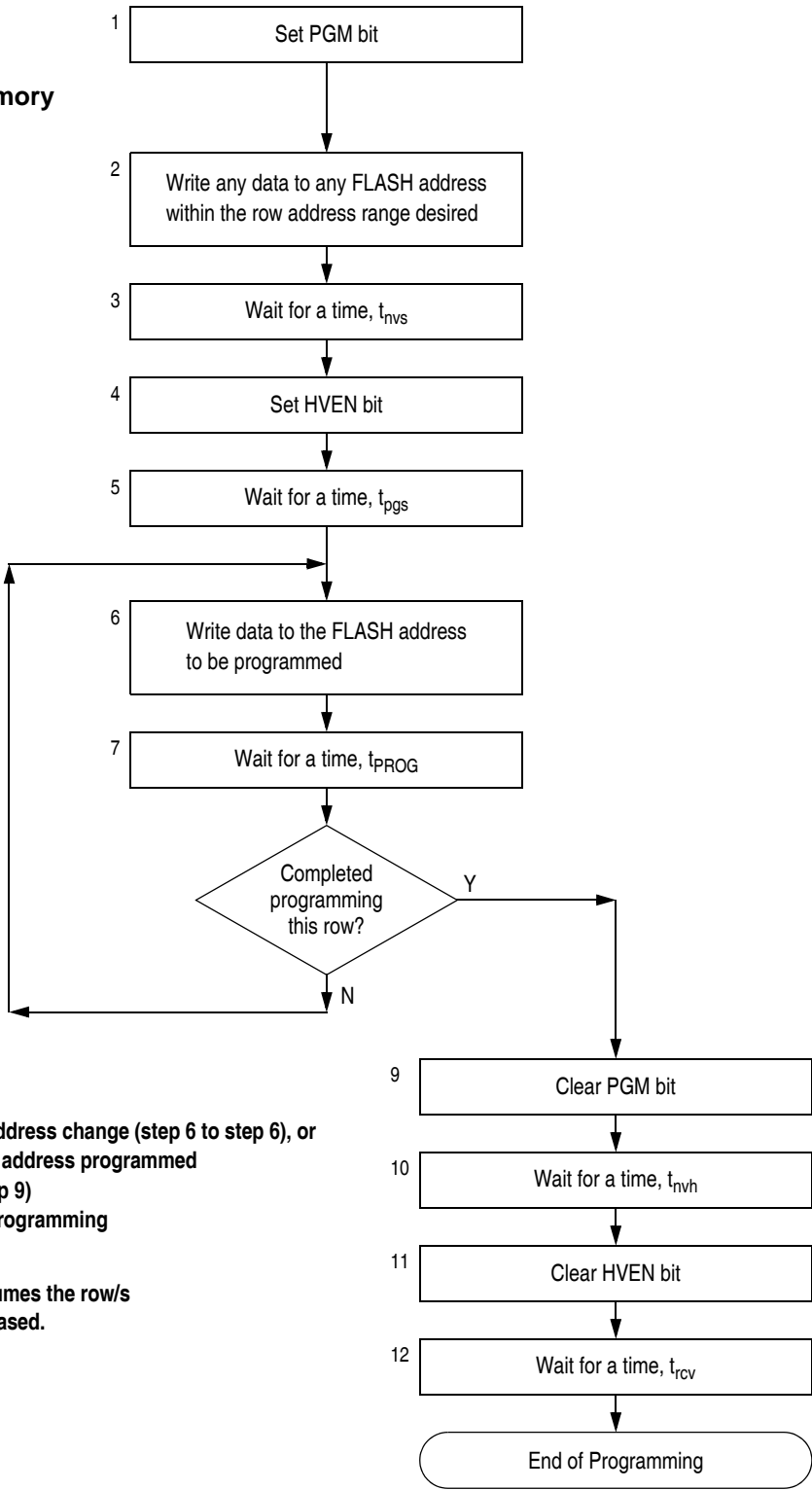
NOTE: *For correct operation, the stack pointer must point only to RAM locations.*

Within page zero are 128 bytes of RAM. Because the location of the stack RAM is programmable, all page zero RAM locations can be used for I/O control and user data or code. When the stack pointer is moved from its reset location at \$00FF, direct addressing mode instructions can access efficiently all page zero RAM locations. Page zero RAM, therefore, provides ideal locations for frequently accessed global variables.

Before processing an interrupt, the CPU uses five bytes of the stack to save the contents of the CPU registers.

NOTE: *For M6805 compatibility, the H register is not stacked.*

Algorithm for programming
a row (32 bytes) of FLASH memory



NOTE:
The time between each FLASH address change (step 6 to step 6), or the time between the last FLASH address programmed to clearing PGM bit (step 6 to step 9) must not exceed the maximum programming time, $t_{PROG\ max}$.
This row program algorithm assumes the row/s to be programmed are initially erased.

Figure 4-2. FLASH Programming Flowchart



6.4.2 Index Register

The 16-bit index register allows indexed addressing of a 64-Kbyte memory space. H is the upper byte of the index register, and X is the lower byte. H:X is the concatenated 16-bit index register.

In the indexed addressing modes, the CPU uses the contents of the index register to determine the conditional address of the operand.

The index register can serve also as a temporary data storage location.

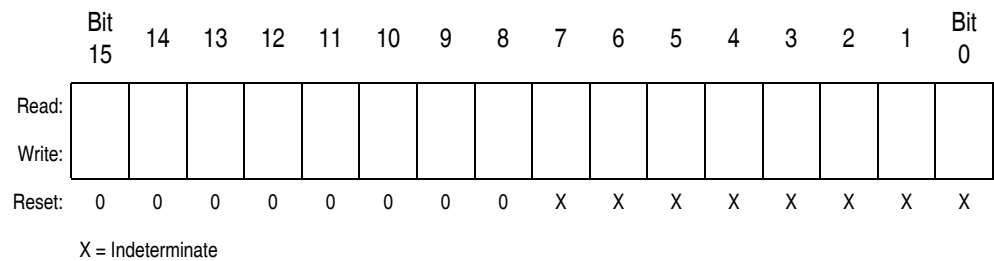


Figure 6-3. Index Register (H:X)

6.4.3 Stack Pointer

The stack pointer is a 16-bit register that contains the address of the next location on the stack. During a reset, the stack pointer is preset to \$00FF. The reset stack pointer (RSP) instruction sets the least significant byte to \$FF and does not affect the most significant byte. The stack pointer decrements as data is pushed onto the stack and increments as data is pulled from the stack.

In the stack pointer 8-bit offset and 16-bit offset addressing modes, the stack pointer can function as an index register to access data on the stack. The CPU uses the contents of the stack pointer to determine the conditional address of the operand.

Table 6-2. Opcode Map

		Bit Manipulation		Branch	Read-Modify-Write					Control		Register/Memory																										
		DIR	DIR	REL	DIR	INH	INH	IX1	SP1	IX	INH	INH	IMM	DIR	EXT	IX2	SP2	IX1	SP1	IX																		
MSB LSB		0	1	2	3	4	5	6	9E6	7	8	9	A	B	C	D	9ED	E	9EE	F																		
0	5 3	BRSET0 DIR	4 2	BSET0 DIR	3 2	BRA REL	4 2	NEG DIR	1 1	NEGA INH	1 1	NEGX INH	2 2	NEG IX1	3 3	NEG SP1	1 1	NEG IX	7 1	RTI INH	3 2	BGE REL	2 2	SUB IMM	3 2	SUB DIR	4 3	SUB EXT	4 3	SUB IX2	5 4	SUB SP2	3 2	SUB IX1	4 3	SUB SP1	2 1	SUB IX
1	5 3	BRCLR0 DIR	4 2	BCLR0 DIR	3 2	BRN REL	5 3	CBEQ DIR	4 3	CBEQA IMM	4 3	CBEQX IMM	5 3	CBEQ IX1+	6 4	CBEQ SP1	2 2	CBEQ IX+	4 1	RTS INH	3 2	BLT REL	2 2	CMP IMM	3 2	CMP DIR	4 3	CMP EXT	4 3	CMP IX2	5 4	CMP SP2	3 2	CMP IX1	4 3	CMP SP1	2 1	CMP IX
2	5 3	BRSET1 DIR	4 2	BSET1 DIR	3 2	BHI REL		7 1	MUL INH	5 1	DIV INH	7 1	NSA INH		2 1	DAA INH		3 2	BGT REL	2 2	SBC IMM	3 2	SBC DIR	4 3	SBC EXT	4 3	SBC IX2	5 4	SBC SP2	3 2	SBC IX1	4 3	SBC SP1	2 1	SBC IX			
3	5 3	BRCLR1 DIR	4 2	BCLR1 DIR	3 2	BLS REL	4 2	COM DIR	1 1	COMA INH	1 1	COMX INH	4 2	COM IX1	5 3	COM SP1	1 1	COM IX	9 1	SWI INH	2 2	BLE REL	2 2	CPX IMM	3 2	CPX DIR	4 3	CPX EXT	4 3	CPX IX2	5 4	CPX SP2	3 2	CPX IX1	4 3	CPX SP1	1 1	CPX IX
4	5 3	BRSET2 DIR	4 2	BSET2 DIR	3 2	BCC REL	4 2	LSR DIR	1 1	LSRA INH	1 1	LSRX INH	4 2	LSR IX1	5 3	LSR SP1	1 1	LSR IX	2 1	TAP INH	2 1	TXS INH	2 2	AND IMM	3 2	AND DIR	4 3	AND EXT	4 3	AND IX2	5 4	AND SP2	3 2	AND IX1	4 3	AND SP1	1 1	AND IX
5	5 3	BRCLR2 DIR	4 2	BCLR2 DIR	3 2	BCS REL	4 2	STHX DIR	3 3	LDHX IMM	4 3	LDHX DIR	3 3	CPHX IMM		4 2	CPHX DIR	1 1	TPA INH	2 1	TSX INH	2 2	BIT IMM	3 2	BIT DIR	4 3	BIT EXT	4 3	BIT IX2	5 4	BIT SP2	3 2	BIT IX1	4 3	BIT SP1	1 1	BIT IX	
6	5 3	BRSET3 DIR	4 2	BSET3 DIR	3 2	BNE REL	4 2	ROR DIR	1 1	RORA INH	1 1	RORX INH	4 2	ROR IX1	5 3	ROR SP1	3 1	ROR IX	2 1	PULA INH		2 2	LDA IMM	3 2	LDA DIR	4 3	LDA EXT	4 3	LDA IX2	5 4	LDA SP2	3 2	LDA IX1	4 3	LDA SP1	1 1	LDA IX	
7	5 3	BRCLR3 DIR	4 2	BCLR3 DIR	3 2	BEQ REL	4 2	ASR DIR	1 1	ASRA INH	1 1	ASRX INH	4 2	ASR IX1	5 3	ASR SP1	3 1	ASR IX	2 1	PSHA INH	1 1	TAX INH	2 2	AIS IMM	3 2	STA DIR	4 3	STA EXT	4 3	STA IX2	5 4	STA SP2	3 2	STA IX1	4 3	STA SP1	1 1	STA IX
8	5 3	BRSET4 DIR	4 2	BSET4 DIR	3 2	BHCC REL	4 2	LSL DIR	1 1	LSLA INH	1 1	LSLX INH	4 2	LSL IX1	5 3	LSL SP1	3 1	LSL IX	2 1	PULX INH	1 1	CLC INH	2 2	EOR IMM	3 2	EOR DIR	4 3	EOR EXT	4 3	EOR IX2	5 4	EOR SP2	3 2	EOR IX1	4 3	EOR SP1	1 1	EOR IX
9	5 3	BRCLR4 DIR	4 2	BCLR4 DIR	3 2	BHCS REL	4 2	ROL DIR	1 1	ROLA INH	1 1	ROLX INH	4 2	ROL IX1	5 3	ROL SP1	3 1	ROL IX	2 1	PSHX INH	1 1	SEC INH	2 2	ADC IMM	3 2	ADC DIR	4 3	ADC EXT	4 3	ADC IX2	5 4	ADC SP2	3 2	ADC IX1	4 3	ADC SP1	1 1	ADC IX
A	5 3	BRSET5 DIR	4 2	BSET5 DIR	3 2	BPL REL	4 2	DEC DIR	1 1	DECA INH	1 1	DECX INH	4 2	DEC IX1	5 3	DEC SP1	3 1	DEC IX	2 1	PULH INH	2 1	CLI INH	2 2	ORA IMM	3 2	ORA DIR	4 3	ORA EXT	4 3	ORA IX2	5 4	ORA SP2	3 2	ORA IX1	4 3	ORA SP1	1 1	ORA IX
B	5 3	BRCLR5 DIR	4 2	BCLR5 DIR	3 2	BMI REL	5 3	DBNZ DIR	3 2	DBNZA INH	3 2	DBNZX INH	5 3	DBNZ IX1	6 4	DBNZ SP1	2 2	DBNZ IX	2 1	PSHH INH	2 1	SEI INH	2 2	ADD IMM	3 2	ADD DIR	4 3	ADD EXT	4 3	ADD IX2	5 4	ADD SP2	3 2	ADD IX1	4 3	ADD SP1	1 1	ADD IX
C	5 3	BRSET6 DIR	4 2	BSET6 DIR	3 2	BMC REL	4 2	INC DIR	1 1	INCA INH	1 1	INCX INH	4 2	INC IX1	5 3	INC SP1	3 1	INC IX	1 1	CLRH INH	1 1	RSP INH		2 2	JMP DIR	3 3	JMP EXT	4 3	JMP IX2		3 2	JMP IX1				2 1	JMP IX	
D	5 3	BRCLR6 DIR	4 2	BCLR6 DIR	3 2	BMS REL	4 2	TST DIR	1 1	TSTA INH	1 1	TSTX INH	3 2	TST IX1	4 3	TST SP1	2 1	TST IX		1 1	NOP INH		4 2	BSR REL	3 2	JSR DIR	4 3	JSR EXT	5 4	JSR IX2		3 2	JSR IX1				2 1	JSR IX
E	5 3	BRSET7 DIR	4 2	BSET7 DIR	3 2	BIL REL		5 3	MOV DD	4 2	MOV DIX+	4 3	MOV IMD		4 2	MOV IX+D		1 2	STOP INH	*		2 2	LDX IMM	3 2	LDX DIR	4 3	LDX EXT	4 3	LDX IX2	5 4	LDX SP2	3 2	LDX IX1	4 3	LDX SP1	1 1	LDX IX	
F	5 3	BRCLR7 DIR	4 2	BCLR7 DIR	3 2	BIH REL	3 2	CLR DIR	1 1	CLRA INH	1 1	CLR INH	3 2	CLR IX1	4 3	CLR SP1	2 1	CLR IX	1 1	WAIT INH	1 1	TXA INH	2 2	AIX IMM	3 2	STX DIR	4 3	STX EXT	4 3	STX IX2	5 4	STX SP2	3 2	STX IX1	4 3	STX SP1	1 1	STX IX

INH Inherent
IMM Immediate
DIR Direct
EXT Extended
DD Direct-Direct
IX+D Indexed-Direct

REL Relative
IX Indexed, No Offset
IX1 Indexed, 8-Bit Offset
IX2 Indexed, 16-Bit Offset
IMD Immediate-Direct
DIX+ Direct-Indexed

SP1 Stack Pointer, 8-Bit Offset
SP2 Stack Pointer, 16-Bit Offset
IX+ Indexed, No Offset with Post Increment
IX1+ Indexed, 1-Byte Offset with Post Increment

*Pre-byte for stack pointer indexed instructions

Low Byte of Opcode in Hexadecimal

MSB LSB	0	High Byte of Opcode in Hexadecimal
0	5 BRSET0 3 DIR	Cycles Opcode Mnemonic Number of Bytes / Addressing Mode

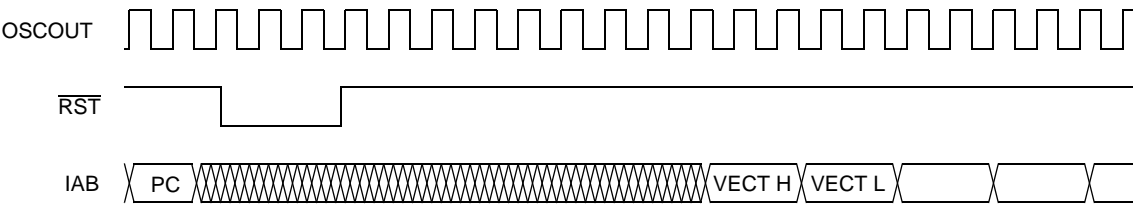


Figure 7-4. External Reset Timing

7.4.2 Active Resets from Internal Sources

All internal reset sources actively pull the $\overline{\text{RST}}$ pin low for 32 2OSCOUT cycles to allow resetting of external peripherals. The internal reset signal IRST continues to be asserted for an additional 32 cycles (**Figure 7-5**). An internal reset can be caused by an illegal address, illegal opcode, COP time-out, or POR. (See **Figure 7-6 . Sources of Internal Reset.**) Note that for POR resets, the SIM cycles through 4096 2OSCOUT cycles during which the SIM forces the $\overline{\text{RST}}$ pin low. The internal reset signal then follows the sequence from the falling edge of $\overline{\text{RST}}$ shown in **Figure 7-5**.

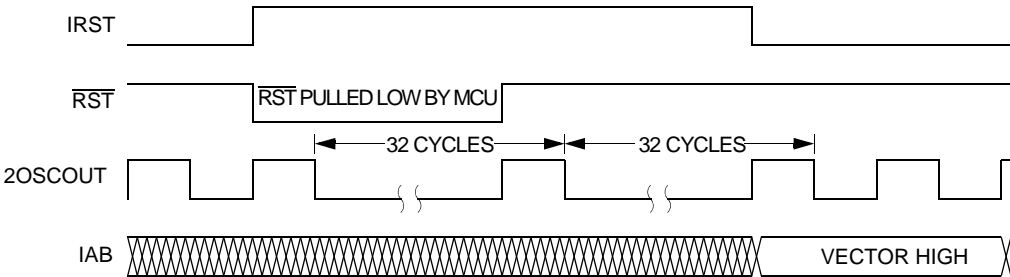


Figure 7-5. Internal Reset Timing

The COP reset is asynchronous to the bus clock.

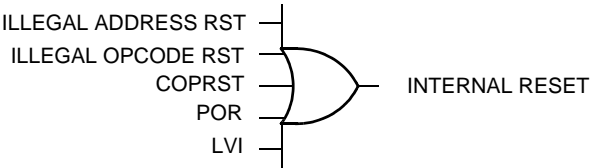


Figure 7-6. Sources of Internal Reset

7.7.2 Stop Mode

In stop mode, the SIM counter is reset and the system clocks are disabled. An interrupt request from a module can cause an exit from stop mode. Stacking for interrupts begins after the selected stop recovery time has elapsed. Reset or break also causes an exit from stop mode.

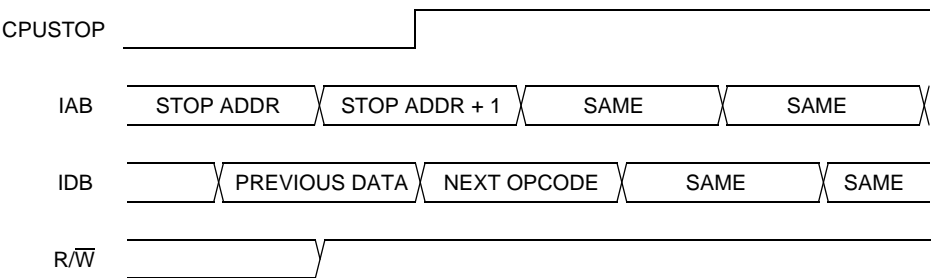
The SIM disables the oscillator signals (OSCOOUT and 2OSCOOUT) in stop mode, stopping the CPU and peripherals. Stop recovery time is selectable using the SSREC bit in the configuration register (CONFIG). If SSREC is set, stop recovery is reduced from the normal delay of 4096 2OSCOOUT cycles down to 32. This is ideal for applications using canned oscillators that do not require long start-up times from stop mode.

NOTE: External crystal applications should use the full stop recovery time by clearing the SSREC bit.

A break interrupt during stop mode sets the SIM break stop/wait bit (SBSW) in the break status register (BSR).

The SIM counter is held in reset from the execution of the STOP instruction until the beginning of stop recovery. It is then used to time the recovery period. [Figure 7-18](#) shows stop mode entry timing.

NOTE: To minimize stop current, all pins configured as inputs should be driven to a logic 1 or logic 0.



NOTE: Previous data can be operand data or the STOP opcode, depending on the last instruction.

Figure 7-18. Stop Mode Entry Timing

7.8.3 Break Flag Control Register (BFCR)

The break control register contains a bit that enables software to clear status bits while the MCU is in a break state.

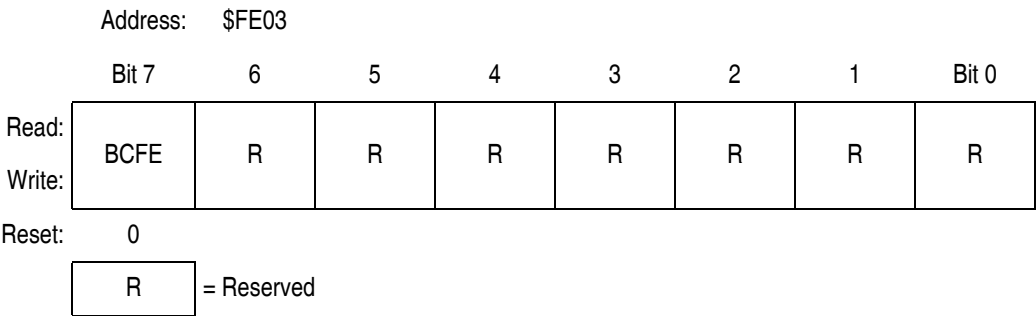


Figure 7-22. Break Flag Control Register (BFCR)

BCFE — Break Clear Flag Enable Bit

This read/write bit enables software to clear status bits by accessing status registers while the MCU is in a break state. To clear status bits during the break state, the BCFE bit must be set.

- 1 = Status bits clearable during break
- 0 = Status bits not clearable during break

8.7 Oscillator During Break Mode

The oscillator continues to drive OSCOUT and 2OSCOUT when the device enters the break state.

9.4.5 Break Signal

A start bit followed by nine low bits is a break signal. (See [Figure 9-6.](#)) When the monitor receives a break signal, it drives the PTB0 pin high for the duration of two bits before echoing the break signal.

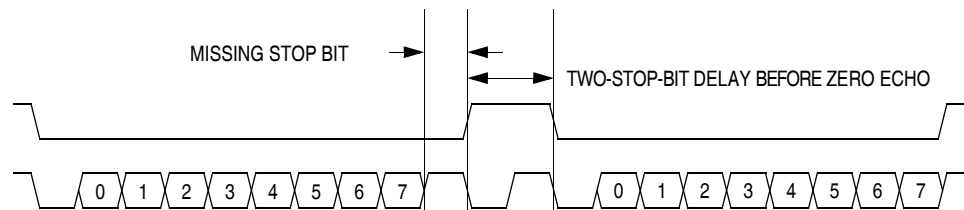


Figure 9-6. Break Transaction

9.4.6 Commands

The monitor ROM uses the following commands:

- READ (read memory)
- WRITE (write memory)
- IREAD (indexed read)
- IWRITE (indexed write)
- READSP (read stack pointer)
- RUN (run user program)

10.5 Functional Description

Figure 10-1 shows the structure of the TIM. The central component of the TIM is the 16-bit TIM counter that can operate as a free-running counter or a modulo up-counter. The TIM counter provides the timing reference for the input capture and output compare functions. The TIM counter modulo registers, TMODH:TMODL, control the modulo value of the TIM counter. Software can read the TIM counter value at any time without affecting the counting sequence.

The two TIM channels are programmable independently as input capture or output compare channels.

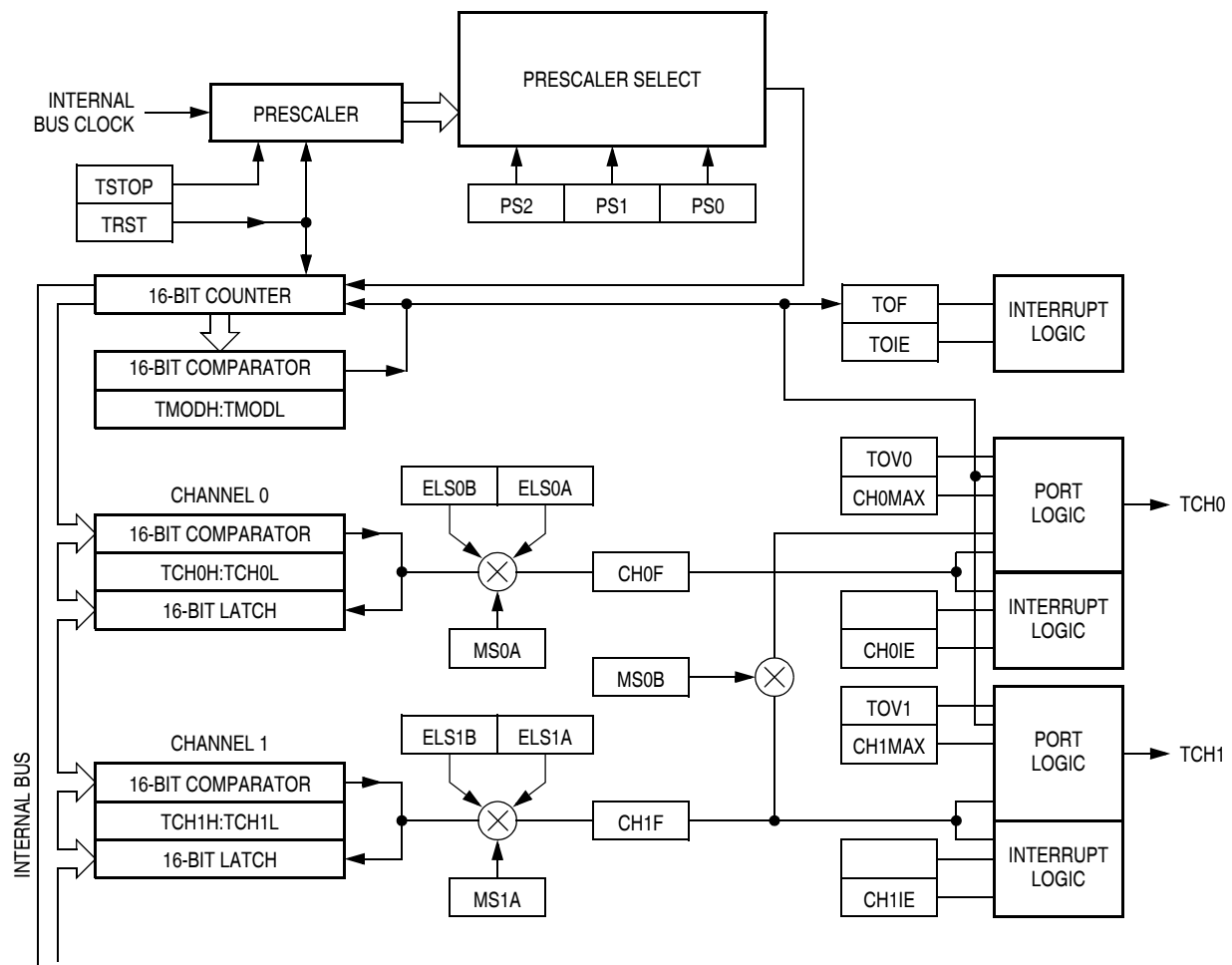


Figure 10-1. TIM Block Diagram

overflow occurs before the clearing sequence is complete, then writing logic zero to TOF has no effect. Therefore, a TOF interrupt request cannot be lost due to inadvertent clearing of TOF. Reset clears the TOF bit. Writing a logic one to TOF has no effect.

1 = TIM counter has reached modulo value

0 = TIM counter has not reached modulo value

TOIE — TIM Overflow Interrupt Enable Bit

This read/write bit enables TIM overflow interrupts when the TOF bit becomes set. Reset clears the TOIE bit.

1 = TIM overflow interrupts enabled

0 = TIM overflow interrupts disabled

TSTOP — TIM Stop Bit

This read/write bit stops the TIM counter. Counting resumes when TSTOP is cleared. Reset sets the TSTOP bit, stopping the TIM counter until software clears the TSTOP bit.

1 = TIM counter stopped

0 = TIM counter active

NOTE: *Do not set the TSTOP bit before entering wait mode if the TIM is required to exit wait mode.*

TRST — TIM Reset Bit

Setting this write-only bit resets the TIM counter and the TIM prescaler. Setting TRST has no effect on any other registers. Counting resumes from \$0000. TRST is cleared automatically after the TIM counter is reset and always reads as logic zero. Reset clears the TRST bit.

1 = Prescaler and TIM counter cleared

0 = No effect

NOTE: *Setting the TSTOP and TRST bits simultaneously stops the TIM counter at a value of \$0000.*

PS[2:0] — Prescaler Select Bits

These read/write bits select one of the seven prescaler outputs as the input to the TIM counter as [Table 10-2](#) shows. Reset clears the PS[2:0] bits.

Table 10-2. Prescaler Selection

PS2	PS1	PS0	TIM Clock Source
0	0	0	Internal Bus Clock ÷ 1
0	0	1	Internal Bus Clock ÷ 2
0	1	0	Internal Bus Clock ÷ 4
0	1	1	Internal Bus Clock ÷ 8
1	0	0	Internal Bus Clock ÷ 16
1	0	1	Internal Bus Clock ÷ 32
1	1	0	Internal Bus Clock ÷ 64
1	1	1	Not available

10.10.2 TIM Counter Registers (TCNTH:TCNTL)

The two read-only TIM counter registers contain the high and low bytes of the value in the TIM counter. Reading the high byte (TCNTH) latches the contents of the low byte (TCNTL) into a buffer. Subsequent reads of TCNTH do not affect the latched TCNTL value until TCNTL is read. Reset clears the TIM counter registers. Setting the TIM reset bit (TRST) also clears the TIM counter registers.

NOTE: *If you read TCNTH during a break interrupt, be sure to unlatch TCNTL by reading TCNTL before exiting the break interrupt. Otherwise, TCNTL retains the value latched during the break.*

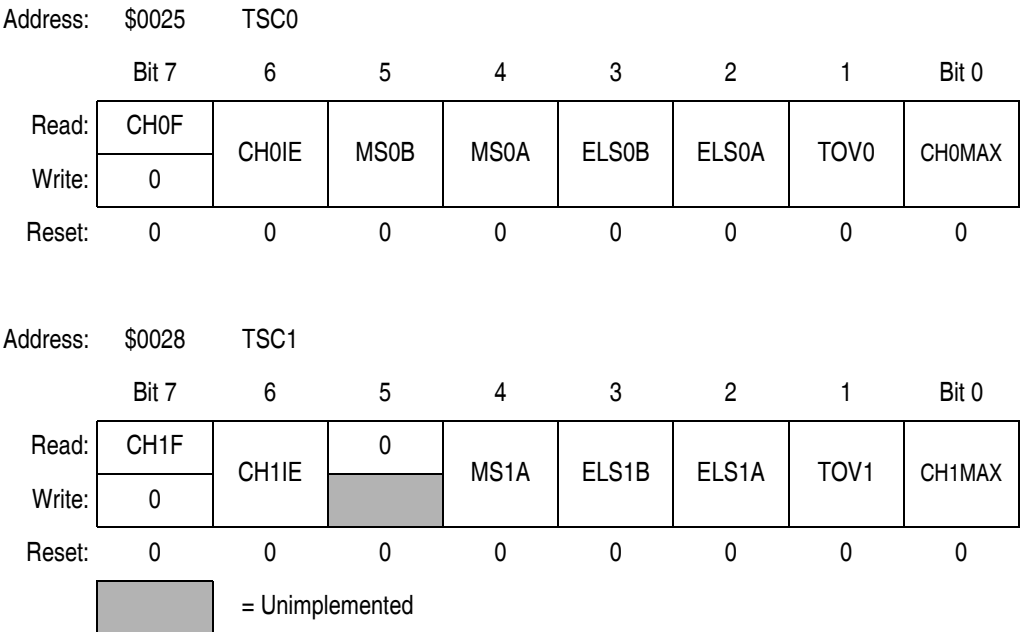


Figure 10-7. TIM Channel Status and Control Registers (TSC0:TSC1)

CHxF — Channel x Flag Bit

When channel x is an input capture channel, this read/write bit is set when an active edge occurs on the channel x pin. When channel x is an output compare channel, CHxF is set when the value in the TIM counter registers matches the value in the TIM channel x registers.

When TIM CPU interrupt requests are enabled (CHxIE=1), clear CHxF by reading the TIM channel x status and control register with CHxF set and then writing a logic zero to CHxF. If another interrupt request occurs before the clearing sequence is complete, then writing logic zero to CHxF has no effect. Therefore, an interrupt request cannot be lost due to inadvertent clearing of CHxF.

Reset clears the CHxF bit. Writing a logic one to CHxF has no effect.

- 1 = Input capture or output compare on channel x
- 0 = No input capture or output compare on channel x

CHxIE — Channel x Interrupt Enable Bit

This read/write bit enables TIM CPU interrupt service requests on channel x. Reset clears the CHxIE bit.

- 1 = Channel x CPU interrupt requests enabled
- 0 = Channel x CPU interrupt requests disabled

13.4 Functional Description

A logic zero applied to the external interrupt pin can latch a CPU interrupt request. [Figure 13-1](#) shows the structure of the IRQ module.

Interrupt signals on the $\overline{\text{IRQ1}}$ pin are latched into the IRQ1 latch. An interrupt latch remains set until one of the following actions occurs:

- Vector fetch — A vector fetch automatically generates an interrupt acknowledge signal that clears the IRQ latch.
- Software clear — Software can clear the interrupt latch by writing to the acknowledge bit in the interrupt status and control register (ISCR). Writing a logic one to the ACK1 bit clears the IRQ1 latch.
- Reset — A reset automatically clears the interrupt latch.

The external interrupt pin is falling-edge-triggered and is software-configurable to be either falling-edge or falling-edge and low-level-triggered. The MODE1 bit in the ISCR controls the triggering sensitivity of the $\overline{\text{IRQ1}}$ pin.

When the interrupt pin is edge-triggered only, the CPU interrupt request remains set until a vector fetch, software clear, or reset occurs.

When the interrupt pin is both falling-edge and low-level-triggered, the CPU interrupt request remains set until both of the following occur:

- Vector fetch or software clear
- Return of the interrupt pin to logic one

The vector fetch or software clear may occur before or after the interrupt pin returns to logic one. As long as the pin is low, the interrupt request remains pending. A reset will clear the latch and the MODE1 control bit, thereby clearing the interrupt even if the pin stays low.

When set, the IMASK1 bit in the ISCR mask all external interrupt requests. A latched interrupt request is not presented to the interrupt priority logic unless the IMASK1 bit is clear.

Section 14. Keyboard Interrupt Module (KBI)

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14.2 Introduction

The keyboard interrupt module (KBI) provides seven independently maskable external interrupts which are accessible via PTA0–PTA6 pins.

14.3 Features

Features of the keyboard interrupt module include the following:

- Seven keyboard interrupt pins with separate keyboard interrupt enable bits and one keyboard interrupt mask
- Software configurable pull-up device if input pin is configured as input port bit
- Programmable edge-only or edge- and level- interrupt sensitivity
- Exit from low-power modes

Section 18. Electrical Specifications

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18.2 Introduction

This section contains electrical and timing specifications.

18.3 Absolute Maximum Ratings

Maximum ratings are the extreme limits to which the MCU can be exposed without permanently damaging it.

NOTE: *This device is not guaranteed to operate properly at the maximum ratings. Refer to Sections 18.6 and 18.9 for guaranteed operating conditions.*

Table 18-1. Absolute Maximum Ratings⁽¹⁾

Characteristic	Symbol	Value	Unit
Supply voltage	V_{DD}	−0.3 to +6.0	V
Input voltage	V_{IN}	$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V
Mode entry voltage, $\overline{IRQ1}$ pin	$V_{DD} + V_{HI}$	$V_{SS} - 0.3$ to +8.5	V
Maximum current per pin excluding V_{DD} and V_{SS}	I	±25	mA
Storage temperature	T_{STG}	−55 to +150	°C
Maximum current out of V_{SS}	I_{MVSS}	100	mA
Maximum current into V_{DD}	I_{MVDD}	100	mA

NOTE:

1. Voltages referenced to V_{SS} .

NOTE: *This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. For proper operation, it is recommended that V_{IN} and V_{OUT} be constrained to the range $V_{SS} \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{DD}$. Reliability of operation is enhanced if unused inputs are connected to an appropriate logic voltage level (for example, either V_{SS} or V_{DD} .)*